

# 23-mm Low-Frequency Glass-Encapsulated Transponder, Read Only, EN 14803 Numbering

## 1 Features

- Best-in-Class Performance Through Patented HDX+ (Half-Duplex) Technology
- Patented Transponder Tuning Provides Stable and High Read Performance
- 80-Bit Read-Only Type
- EN 14803 Numbering
- Insensitive to Almost All Nonmetallic Materials

## 2 Applications

- Waste Container Management

## 3 Description

Texas Instruments 23-mm low-frequency (LF) glass transponders provide superior performance and operate at a resonance frequency of 134.2 kHz. The products are compliant to ISO/IEC 11784/11785 global open standards. Texas Instruments LF glass transponders are manufactured with TI's patented tuning process to provide consistent read performance. Prior to delivery, the transponders undergo complete functional and parametric testing, to provide the high quality customers have come to expect from TI.



## 4 Specifications

### 4.1 Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

		TRPGR30ENATGA
T <sub>A</sub>	Operating temperature	-25°C to 70°C
T <sub>STG</sub>	Storage temperature	-40°C to 85°C

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Specifications* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 4.2 Characteristics

PARAMETER	TRPGR30ENATGA
Functionality	Read only
Memory (bits)	80 (64-bit unique ID + 16-bit BCC)
Memory (pages)	1
Resonance frequency	134.6 kHz
Modulation	FSK (frequency shift keying) 134.2 kHz and 124.2 kHz
Transmission principle	HDX (half duplex)
Power source	Powered from the reader signal (battery-less)
Typical reading range	≤110 cm <sup>(1)</sup>
Typical reading time	70 ms
Case material	Glass
Protection glass	Hermetically sealed
EMC	Programmed code is not affected by natural electromagnetic interference or x-rays
Signal penetration	Transponder can be read through almost all nonmetallic material
Mechanical shock	IEC 60068-2-32 free-fall drop test, 20 times from 1.5-m height
Dimensions	Ø 3.85 ± 0.05 mm x 23.1 ± 0.5 mm
Weight	0.8 g

(1) Depends on RF regulation in country of use, the reader antenna configuration, and the environmental conditions.



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**PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TRPGR30ENATGA	Active	Production	RFIDT (TGA)   0	2000   LARGE T&R	Yes	Call TI	N/A for Pkg Type	-25 to 70	
TRPGR30ENATGA.B	Active	Production	RFIDT (TGA)   0	2000   LARGE T&R	Yes	Call TI	N/A for Pkg Type	-25 to 70	

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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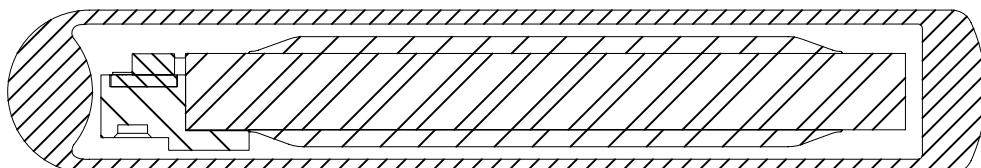
## MECHANICAL DATA

TGA (R-RFID-NO)

RFIDT



A-A



4211903/A 06/11

NOTES:

- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5-1994.
- B. This drawing is subject to change without notice.
- C. HDX+ 23mm Glass TRP Cap on Die.

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